



PATENT

1725  
#11/B

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Benjamin Sonnenreich et al. : Art Unit: 1725  
Serial No.: 09/772,421 : Examiner: Len Tran  
Filed: January 30, 2001 :  
For: BONDING TOOL WITH :  
POLYMER COATING :

AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

S I R :

Responsive to the Office Action dated **June 7, 2002**, please amend the above-identified application as follows:

CLAIMS:

Please cancel claim 6.

Please replace claims 1, 7, 8, and 10 with the following amended claims:

- 1 1. (Amended) A bonding tool for bonding a wire to a substrate, the  
2 bonding tool having a body and a working tip coupled to one end of the body, and  
3 comprising:  
4 an orifice extending along a longitudinal axis of the body and the working  
5 tip; and  
6 a polymer coating disposed over at least a portion of a surface of the  
7 orifice.

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